

LASER DIODE
NX7304BG-CC, NX7304CG-CC1 310 nm InGaAsP MQW-DFB LASER DIODE
COAXIAL MODULE FOR FIBEROPTIC COMMUNICATIONS

★ DESCRIPTION

The NX7304BG-CC and NX7304CG-CC are 1 310 nm Multiple Quantum Well (MQW) structured Fabry-Perot (FP) laser diode coaxial modules with single mode fiber.

These modules are ideal as a light source for ITU-T recommended Synchronous Digital Hierarchy (SDH) system, for fiberoptic communications as SONET and for digital transmission.

FEATURES

- Center wavelength $\lambda_c = 1\,310\text{ nm}$
- Optical output power $P_r = 2.0\text{ mW MIN.}$
- Low threshold current $I_{th} = 10\text{ mA}$
- High cut-off frequency $f_c = 2.0\text{ GHz}$
- Wide operating temperature range $T_c = -40\text{ to }+85^\circ\text{C}$
- InGaAs monitor PIN-PD
- With SC-UPC connector
- Based on Telcordia reliability

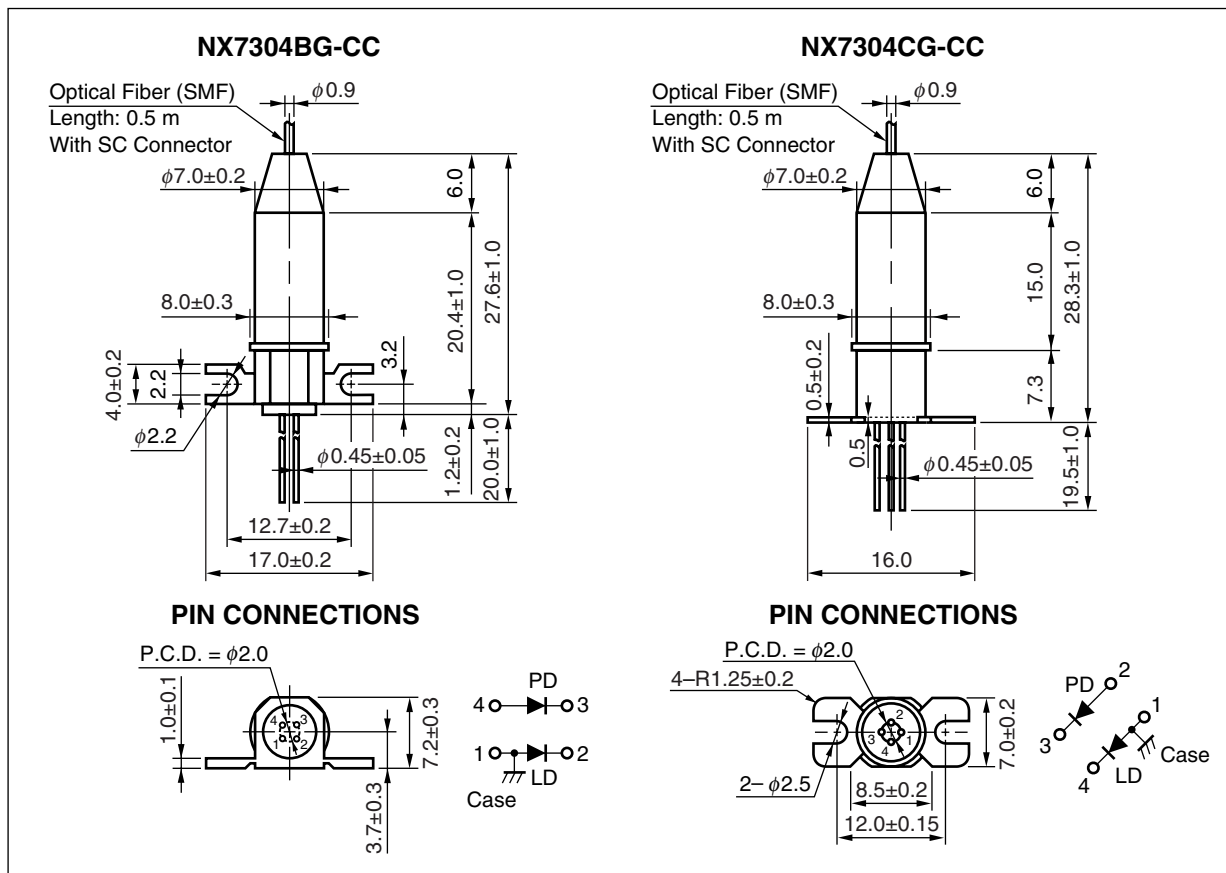
NX7304BG-CC



NX7304CG-CC

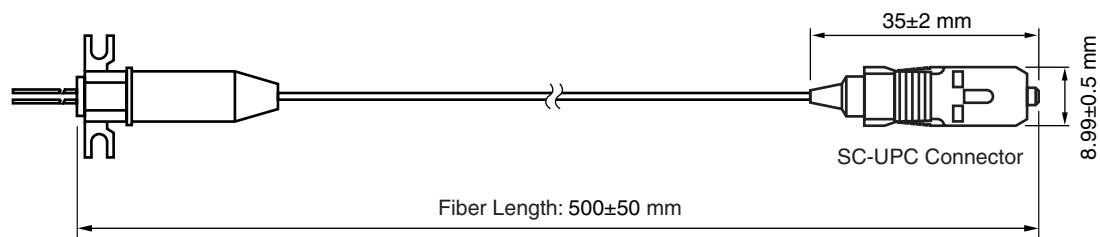
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★ PACKAGE DIMENSIONS (UNIT : mm)



OPTICAL FIBER CHARACTERISTICS

Parameter	Specification	Unit
Mode Field Diameter	9.5 \pm 1	μ m
Cladding Diameter	125 \pm 2	μ m
Maximum Cladding Noncircularity	2	%
Maximum Core/Cladding Concentricity	1.6	%
Outer Diameter	0.9 \pm 0.1	mm
Cut-off Wavelength	1 100 to 1 270	nm
Minimum Fiber Bending Radius	30	mm
Fiber Length	500 \pm 50	mm
Flammability	UL1581 VW-1	



★ ORDERING INFORMATION

Part Number	Flange Type	Available Connector
NX7304BG-CC	Flat Mount Flange	With SC-UPC Connector
NX7304CG-CC	Vertical Mount Flange	

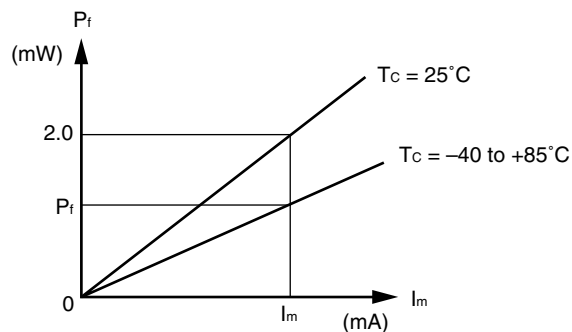
ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Ratings	Unit
Optical Output Power from Fiber	P_r	5.0	mW
Forward Current of LD	I_F	150	mA
Reverse Voltage of LD	V_R	2.0	V
Forward Current of PD	I_F	10	mA
Reverse Voltage of PD	V_R	20	V
Operating Case Temperature	T_c	−40 to +85	°C
Storage Temperature	T_{stg}	−40 to +85	°C
★ Lead Soldering Temperature	T_{sld}	350 (3 sec.)	°C
Relative Humidity (noncondensing)	RH	85	%

ELECTRO-OPTICAL CHARACTERISTICS (T_c = 25°C, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Operating Voltage	V _{op}	P _f = 2.0 mW		1.1	1.3	V
Threshold Current	I _{th}			10	25	mA
		T _c = 85°C		25	50	
Modulation Current	I _{mod}	P _f = 2.0 mW		15	20	mA
Differential Efficiency	η _d		0.100	0.150		W/A
		T _c = 85°C	0.075	0.100		
Center Wavelength	λ _c	P _f = 2.0 mW, RMS (−20 dB)	1 290	1 310	1 330	nm
		T _c = −40 to +85°C	1 260		1 360	
Temperature Dependence of Center Wavelength	Δλ/ΔT	T _c = −40 to +85°C		0.4	0.5	nm/°C
Spectral Width	σ	P _f = 0.2 mW, RMS (−20 dB)		1.3	2.5	nm
		T _c = 85°C		1.5	4.0	
Rise Time	t _r	10-90%		0.2	0.5	ns
Fall Time	t _f	90-10%		0.3	0.5	ns
Monitor Current	I _m	V _R = 5 V, P _f = 2.0 mW	100	700		μA
Monitor Dark Current	I _D	V _R = 5 V		0.1	10	nA
Tracking Error	γ [†]	I _m = const., T _c = −40 to +85°C			1.0	dB

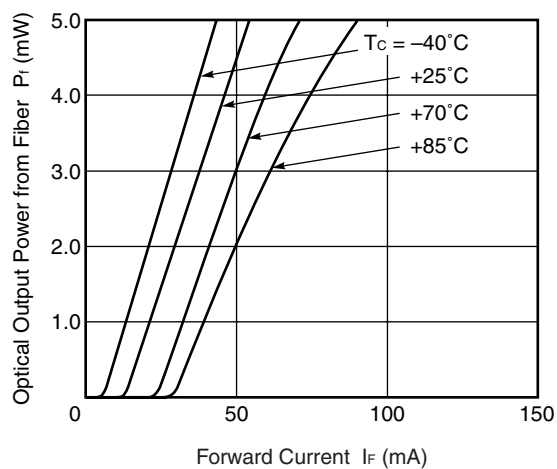
*1 Tracking Error: γ



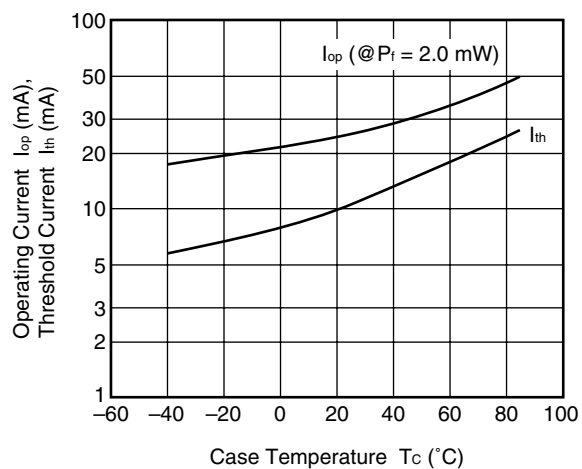
$$\gamma = \left| 10 \log \frac{P_f}{2.0} \right| \text{ [dB]}$$

TYPICAL CHARACTERISTICS ($T_c = -40$ to $+85^\circ\text{C}$, unless otherwise specified)

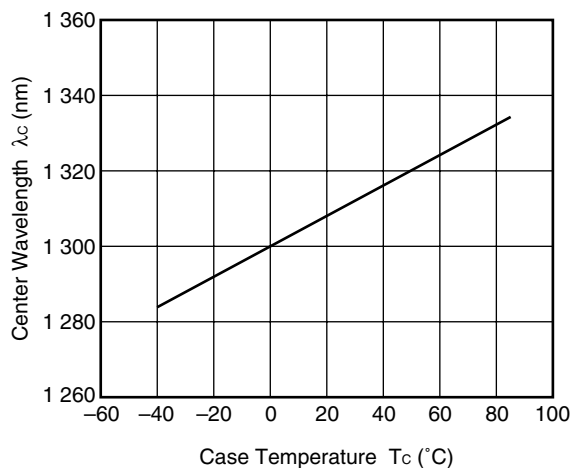
OPTICAL OUTPUT POWER FROM FIBER vs. FORWARD CURRENT



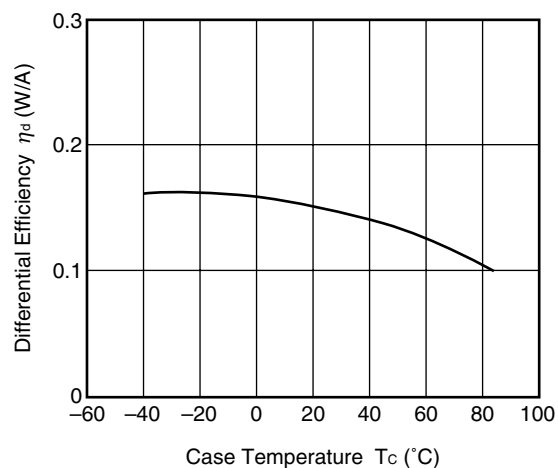
OPERATING CURRENT AND THRESHOLD CURRENT vs. CASE TEMPERATURE



TEMPERATURE DEPENDENCE OF CENTER WAVELENGTH

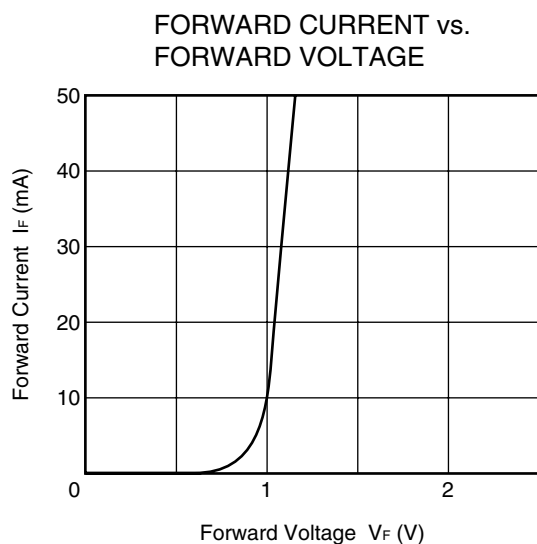
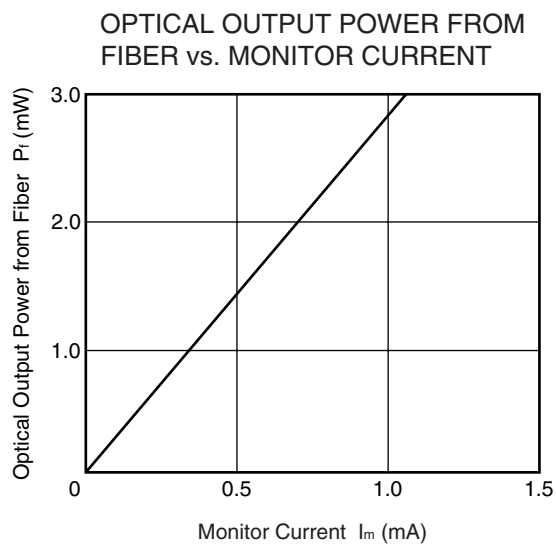
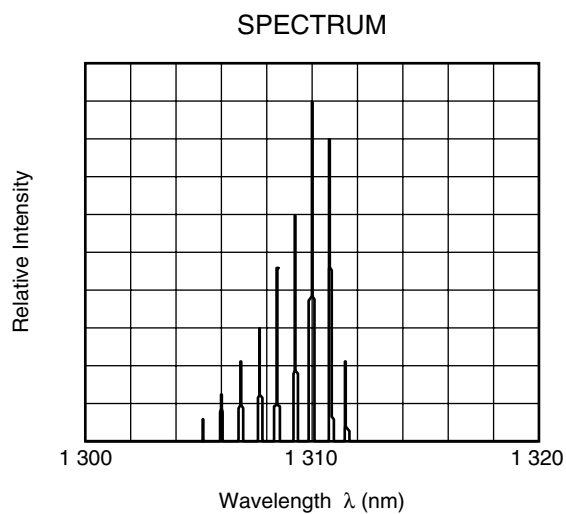


TEMPERATURE DEPENDENCE OF DIFFERENTIAL EFFICIENCY



Remark The graphs indicate nominal characteristics.

TYPICAL CHARACTERISTICS ($T_c = 25^\circ\text{C}$, unless otherwise specified)



Remark The graphs indicate nominal characteristics.

★ FP-LD FAMILY

Part Number	Absolute Maximum Ratings		Electro-Optical Characteristics (T _c = -40 to +85°C)				Applications	Package
	T _c (°C)	T _{stg} (°C)	P _i (mW)	λ _c (nm)		σ (nm)		
			TYP.	MIN.	MAX.	MAX.		
NX7301BA-CC NX7301CA-CC	-40 to +85	-40 to +85	0.2	1 261	1 360	4.0	156 Mb/s: STM-1 (I-1, S-1.1) 622 Mb/s: STM-4 (I-4)	Coaxial
NX7302BA-CC NX7302CA-CC	-40 to +85	-40 to +85	0.2	1 274	1 356	2.5	622 Mb/s: STM-4 (S-4.1)	Coaxial
NX7303BA-CC NX7303CA-CC	-40 to +85	-40 to +85	1.0	1 263	1 360	4.0	156 Mb/s: STM-1 (L-1.1)	Coaxial
NX7304BG-CC NX7304CG-CC	-40 to +85	-40 to +85	2.0 ^{*1}	1 260	1 360	4.0	For fiberoptic communications	Coaxial

*1 MIN.

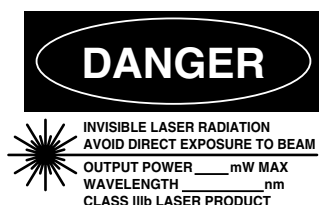
★ **REFERENCE**

Document Name	Document No.
OPTICAL SEMICONDUCTOR DEVICES FOR FIBEROPTIC COMMUNICATIONS SELECTION GUIDE	PL10161E
Opto-Electronics Devices Pamphlet	PX10160E

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M8E 00.4-0110

SAFETY INFORMATION ON THIS PRODUCT



SEMICONDUCTOR LASER



AVOID EXPOSURE-Invisible
Laser Radiation is emitted from
this aperture

Warning Laser Beam	<p>A laser beam is emitted from this diode during operation. The laser beam, visible or invisible, directly or indirectly, may cause injury to the eye or loss of eyesight.</p> <ul style="list-style-type: none"> • Do not look directly into the laser beam. • Avoid exposure to the laser beam, any reflected or collimated beam.
Caution GaAs Products	<p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"> • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. <ol style="list-style-type: none"> 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.
Caution Optical Fiber	<p>A glass-fiber is attached on the product. Handle with care.</p> <ul style="list-style-type: none"> • When the fiber is broken or damaged, handle carefully to avoid injury from the damaged part or fragments.

► For further information, please contact

NEC Compound Semiconductor Devices, Ltd. <http://www.ncsd.necel.com/>

E-mail: salesinfo@ml.ncsd.necel.com (sales and general)

techinfo@ml.ncsd.necel.com (technical)

5th Sales Group, Sales Division TEL: +81-44-435-1588 FAX: +81-44-435-1579

NEC Compound Semiconductor Devices Hong Kong Limited

E-mail: ncsd-hk@elhk.nec.com.hk (sales, technical and general)

Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309

Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859

Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH <http://www.ee.nec.de/>

TEL: +49-211-6503-0 FAX: +49-211-6503-1327

California Eastern Laboratories, Inc. <http://www.cel.com/>

TEL: +1-408-988-3500 FAX: +1-408-988-0279